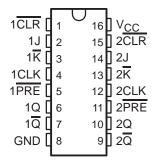
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 Package Options Include Plastic Small-Outline (D) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

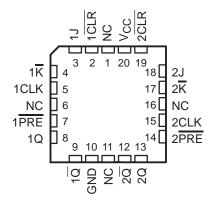
TYPE	TYPICAL MAXIMUM CLOCK FREQUENCY (MHz)	TYPICAL POWER DISSIPATION PER FLIP-FLOP (mW)
'ALS109A	50	6
'AS109A	129	29

#### description

These devices contain two independent J- $\overline{K}$ positive-edge-triggered flip-flops. A low level at the preset (PRE) or clear (CLR) inputs sets or resets the outputs regardless of the levels of the other inputs. When PRE and CLR are inactive (high), data at the J and  $\overline{K}$  inputs meeting the setup-time requirements are transferred to the outputs on the positive-going edge of the clock (CLK) pulse. Clock triggering occurs at a voltage level and is not directly related to the rise time of the clock pulse. Following the hold-time interval, data at the J and  $\overline{K}$  inputs can be changed without affecting the levels at the outputs. These versatile flip-flops can perform as toggle flip-flops by grounding  $\overline{K}$  and tying J high. They also can perform as D-type flip-flops if J and  $\overline{K}$  are tied SN54ALS109A, SN54AS109A . . . J PACKAGE SN74ALS109A, SN74AS109A . . . D OR N PACKAGE (TOP VIEW)



SN54ALS109A, SN54AS109A . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

The SN54ALS109A and SN54AS109A are characterized for operation over the full military temperature range of -55°C to 125°C. The SN74ALS109A and SN74AS109A are characterized for operation from 0°C to 70°C.

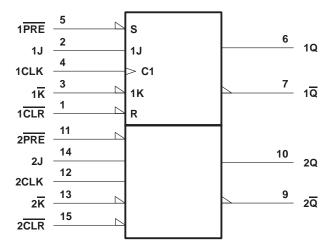
#### **FUNCTION TABLE**

INPUTS					OUTI	PUTS
PRE	CLR	CLK	J	K	Q	Q
L	Н	Х	Χ	Х	Н	L
Н	L	X	Χ	X	L	Н
L	L	X	Χ	X	H <sup>†</sup>	H <sup>†</sup>
Н	Н	$\uparrow$	L	L	L	н
Н	Н	$\uparrow$	Н	L	Tog	gle
Н	Н	$\uparrow$	L	Н	Q0	Q <sub>0</sub>
Н	Н	$\uparrow$	Н	Н	Н	L
Н	Н	L	Χ	X	Q0	Q <sub>0</sub>

† The output levels in this configuration are not specified to meet the minimum levels for V<sub>OH</sub> if the lows at PRE and CLR are near V<sub>IL</sub> maximum. Furthermore, this configuration is nonstable; that is, it does not persist when either PRE or CLR returns to its inactive (high) level.

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### logic symbol†



<sup>&</sup>lt;sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for the D, J, and N packages.

## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage, V <sub>CC</sub>	
Input voltage, V <sub>I</sub>	7 V
Operating free-air temperature range, T <sub>A</sub> : SN54ALS109A	
SN74ALS109A	0°C to 70°C
Storage temperature range	65°C to 150°C

<sup>‡</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

#### recommended operating conditions

			SNS	54ALS10	9A	SN74ALS109A		9A	UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage	1	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage		2			2			V
V <sub>IL</sub>	Low-level input voltage				0.7			0.8	V
IOH	High-level output current				-0.4			-0.4	mA
loL	Low-level output current				4			8	mA
fclock	Clock frequency		0		30	0		34	MHz
		PRE or CLR low	15			15			
t <sub>W</sub>	Pulse duration	CLK high	16.5			14.5			ns
		CLK low	16.5			14.5			
	Outure the shadows OLIVA	Data	15			15			no
t <sub>su</sub>	Setup time before CLK↑	PRE or CLR inactive	10			10			ns
t <sub>h</sub>	Hold time after CLK↑	Data	0			0			ns
TA	Operating free-air temperature	·	-55		125	0		70	°C



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#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		SN5	4ALS10	9A	SN7	4ALS10	9A	UNIT
				MIN	TYP	MAX	MIN	TYP <sup>†</sup>	MAX	UNII
VIK		V <sub>CC</sub> = 4.5 V,	I <sub>I</sub> = -18 mA			-1.5			-1.5	V
Vон		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$	$I_{OH} = -0.4 \text{ mA}$	V <sub>CC</sub> -2			V <sub>CC</sub> -2			V
Vo.		V <sub>CC</sub> = 4.5 V	$I_{OL} = 4 \text{ mA}$		0.25	0.4		0.25	0.4	V
VOL		VCC = 4.5 V	$I_{OL} = 8 \text{ mA}$					0.35	0.5	V
l	CLK, J, or K	V F-V	VI = 7 V			0.1			0.1	mA
''	PRE or CLR	V <sub>CC</sub> = 5.5 V,	$CC = 5.5 \text{ V}, \qquad V = 7 \text{ V}$			0.2			0.2	IIIA
I	CLK, J, or K	V00 - 5 5 V	\/ 2 7 \/		20				20	^
l IH	PRE or CLR	V <sub>CC</sub> = 5.5 V,	$C = 5.5 \text{ V}, \qquad V_{\parallel} = 2.7 \text{ V}$			40			40	μΑ
1	CLK, J, or K	V 55V	V: 0.4.V			-0.2			-0.2	A
IIL	PRE or CLR	V <sub>CC</sub> = 5.5 V,	V <sub>I</sub> = 0.4 V			-0.4			-0.4	mA
IO <sup>‡</sup>		V <sub>CC</sub> = 5.5 V,	V <sub>O</sub> = 2.25 V	-20		-112	-30		-112	mA
ICC		V <sub>CC</sub> = 5.5 V,	See Note 1		2.4	4		2.4	4	mA

## switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	C <sub>L</sub> R <sub>I</sub>	= 50 pF = 500 =	V to 5.5 V =, ⊇, o MAX§	,	UNIT
	, ,	, , ,	SN54AL	S109A	SN74AL		
			MIN	MAX	MIN	MAX	
f <sub>max</sub>			30		34		MHz
t <sub>PLH</sub>	<u> </u>		3	17	3	13	ns
t <sub>PHL</sub>	PRE or CLR	Q or $\overline{\mathbb{Q}}$	5	17	5	15	115
<sup>t</sup> PLH	CLK	Q or Q	5	21	5	16	ns
<sup>t</sup> PHL	OLK	QUIQ	5	20	5	18	115

<sup>§</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

<sup>†</sup> All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C. ‡ The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I<sub>OS</sub>. NOTE 1: I<sub>CC</sub> is measured with J, K, CLK, and PRE grounded, then with J, K, CLK, and CLR grounded.

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## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V <sub>CC</sub>	7 V
Input voltage, V <sub>I</sub>	7 V
Operating free-air temperature range, T <sub>A</sub> : SN54AS109A	
SN74AS109A	0°C to 70°C
Storage temperature range	65°C to 150°C

### recommended operating conditions

			SN	54AS10	9A	SN74AS109A		UNIT	
			MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage		4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage		2			2			V
V <sub>IL</sub>	Low-level input voltage				0.8			0.8	V
loh	High-level output current				-2			-2	mA
lOL	Low-level output current				20			20	mA
fclock*	Clock frequency		0		90	0		105	MHz
		PRE or CLR low	4			4			
t <sub>W</sub> *	Pulse duration	CLK high	4			4			ns
		CLK low	5.5			5.5			
+ *	Catura time a historia CLIVA	Data	5.5			5.5			ns
t <sub>su</sub> *	u* Setup time before CLK↑	PRE or CLR inactive	2			2			110
th*	Hold time after CLK↑	Data	0			0			ns
TA	Operating free-air temperature		-55		125	0		70	°C

<sup>\*</sup> On products compliant to MIL-STD-883, Class B, this parameter is based on characterization data but is not production tested.

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		SN	54AS109	)A	SN	74AS109	)A	UNIT
				MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT
VIK		$V_{CC} = 4.5 \text{ V},$	I <sub>I</sub> = -18 mA			-1.2			-1.2	V
Vон		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$	$I_{OH} = -2 \text{ mA}$	V <sub>CC</sub> -2			V <sub>CC</sub> -2			V
VOL		$V_{CC} = 4.5 V,$	$I_{OL} = 20 \text{ mA}$		0.25	0.5		0.25	0.5	V
l <sub>l</sub>		$V_{CC} = 5.5 \text{ V},$	V <sub>I</sub> = 7 V			0.1			0.1	mA
I	CLK, J, or K	V <sub>CC</sub> = 5.5 V,	$CC = 5.5 \text{ V},$ $V_1 = 2.7 \text{ V}$			20			20	μΑ
IH	PRE or CLR	VCC = 5.5 V,	V   = 2.7 V			40			40	μΑ
1	CLK, J, or K	Vcc = 5.5 V,	V <sub>I</sub> = 0.4 V			-0.5			-0.5	mA
IIL.	PRE or CLR	VCC = 5.5 V,	V  = 0.4 V			-1.8			-1.8	IIIA
IO§		$V_{CC} = 5.5 V,$	$V_0 = 2.25 V$	-30		-112	-30		-112	mA
ICC		V <sub>CC</sub> = 5.5 V,	See Note 1		11.5	17		11.5	17	mA

<sup>‡</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .



<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

<sup>§</sup> The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, IOS. NOTE 1: ICC is measured with J, K, CLK, and PRE grounded, then with J, K, CLK, and CLR grounded.

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## switching characteristics (see Figure 1)

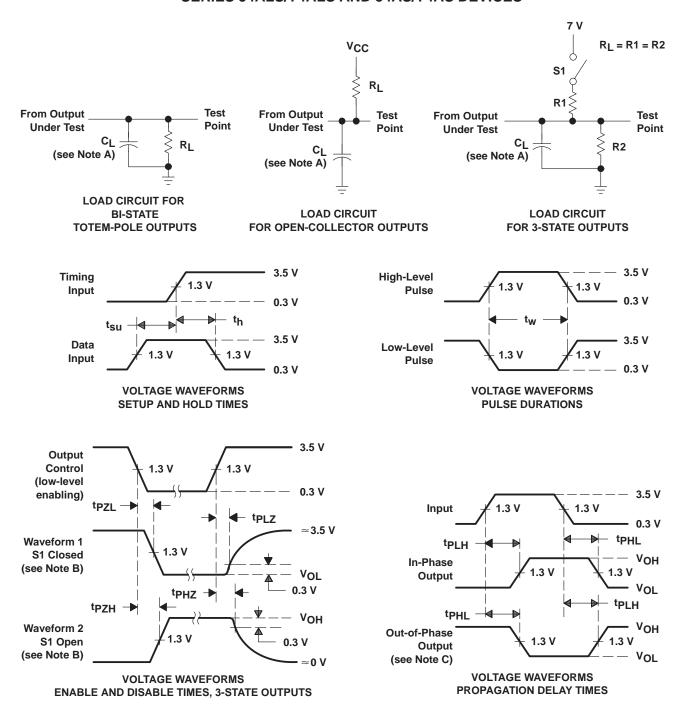
PARAMETER	FROM (INPUT)	TO (OUTPUT)	C	CL = 50   R <sub>I</sub> = 500			UNIT
	, ,	, , ,	SN54A	S109A	SN74A		
			MIN	MAX	MIN	MAX	
f <sub>max</sub> *			90		105		MHz
t <sub>PLH</sub>	PRE or CLR	Q or $\overline{\mathbb{Q}}$	2	9	2	8	ns
t <sub>PHL</sub>	PRE OF CLR	Q or Q	3.5	11.5	3.5	10.5	115
t <sub>PLH</sub>	CLK	Q or Q	2.5	10	2.5	9	ns
t <sub>PHL</sub>		QUIQ	3.5	10.5	3.5	9	115

<sup>\*</sup> On products compliant to MIL-STD-883, Class B, this parameter is based on characterization data but is not production tested.

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

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#### PARAMETER MEASUREMENT INFORMATION SERIES 54ALS/74ALS AND 54AS/74AS DEVICES



NOTES: A. C<sub>I</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
- D. All input pulses have the following characteristics:  $PRR \le 1$  MHz,  $t_r = t_f = 2$  ns, duty cycle = 50%.
- E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms



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